

P-Channel 60 V (D-S) MOSFET

| PRODUCT SUMMARY | | | | | | |
|---------------------|------------------------------------|---------------------------------|----------------------|--|--|--|
| V _{DS} (V) | $R_{DS(on)}(\Omega)$ | I _D (A) ^d | Q _g (Typ) | | | |
| - 60 | 0.053 at V _{GS} = - 10 V | - 25 | 26 | | | |
| - 60 | 0.062 at V _{GS} = - 4.5 V | - 20 | 20 | | | |

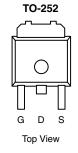
FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFET
- 100 % UIS Tested
- Compliant to RoHS Directive 2002/95/EC

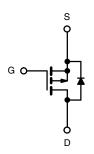


APPLICATIONS

- · High Side Switch for Full Bridge Converter
- DC/DC Converter for LCD Display



Drain Connected to Tab



P-Channel MOSFET

| ABSOLUTE MAXIMUM RATINGS $(T_A = 2)$ | 25 °C, unless otherw | rise note) | | | |
|--|-------------------------|-----------------------------------|---------------------|-----|--|
| Parameter | Symbol | Limit | Unit | | |
| Drain-Source Voltage | | V _{DS} | - 60 | V | |
| Gate-Source Voltage | | V _{GS} | ± 20 | 1 v | |
| Continuous Drain Current (T _J = 150 °C) | T _C = 25 °C | I- | - 25 | | |
| Continuous Drain Current (1) = 130 °C) | T _C = 125 °C | I _D | - 20 | | |
| Pulsed Drain Current | | I _{DM} | - 100 | A | |
| Avalanche Current, Single Pulse | L = 0.1 mH | I _{AS} | - 22 | 1 | |
| Repetitive Avalanche Energy, Single Pulse ^a | L = 0.1 Min | E _{AS} | 24.2 | mJ | |
| Dower Discipation | T _C = 25 °C | P _D | 38.5 ^c | w | |
| Power Dissipation | T _A = 25 °C | | 2.3 ^{b, c} |] " | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | - 55 to 150 | °C | |

| THERMAL RESISTANCE RATINGS | | | | | | |
|--|--------------|------------|---------|---------|------|--|
| Parameter | | Symbol | Typical | Maximum | Unit | |
| Marian and Landing to Ambient | t ≤ 10 s | R_{thJA} | 17 | 21 | °C/W | |
| Maximum Junction-to-Ambient ^b | Steady State | | 45 | 55 | | |
| Maximum Junction-to-Case | | R_{thJC} | 2.7 | 3.25 | | |

Notes:

- a. Duty cycle \leq 1 %.
- b. When mounted on 1" square PCB (FR-4 material).
- c. See SOA curve for voltage derating.
- d. Based up on T_C = 25 °C.



| Parameter Sy | | Test Conditions | | Min . Typ. | | Unit | |
|---|------------------------------|--|----------|------------|-------|------|--|
| Static | | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | $V_{GS} = 0 \text{ V}, I_{D} = -250 \mu\text{A}$ | - 60 | | | ٧ | |
| Gate Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_{D} = -250 \mu A$ | - 1 | | - 3 | V | |
| Gate-Body Leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$ | | | ± 100 | nA | |
| | | V _{DS} = - 60 V, V _{GS} = 0 V | | | - 1 | | |
| Zero Gate Voltage Drain Current | I _{DSS} | $V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$ | | | - 50 | μΑ | |
| | | $V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 150 ^{\circ} \text{ C}$ | | | - 125 | | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} = -5 \text{ V}, V_{GS} = -10 \text{ V}$ | - 30 | | | Α | |
| | | V _{GS} = - 10 V, I _D = - 10 A | | 0.053 | 0.060 | | |
| Drain Course On State Besistance | Book | V _{GS} = - 10 V, I _D = - 10 A, T _J = 125 °C | | | 0.102 | Ω | |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | V _{GS} = - 10 V, I _D = - 10 A, T _J = 150 °C | | | 0.120 | 52 | |
| | | $V_{GS} = -4.5 \text{ V}, I_D = -5 \text{ A}$ | 0.062 0. | | 0.070 | 1 | |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = - 15 V, I _D = - 10 A | | 22 | | S | |
| Dynamic ^b | | | | | | | |
| Input Capacitance | C _{iss} | | | 1140 | 1710 | pF | |
| Output Capacitance | C _{oss} | $V_{GS} = 0 \text{ V}, V_{DS} = -25 \text{ V}, f = 1 \text{ MHz}$ | | 130 | | | |
| Reverse Transfer Capacitance | C _{rss} | | | 90 | | | |
| Total Gate Charge ^c | Qg | | | 26 | 40 | | |
| Gate-Source Charge ^c | Q _{gs} | $V_{DS} = -30 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -10 \text{ A}$ | | 4.5 | | nC | |
| Gate-Drain Charge ^c | Q _{gd} | | | 7 | | | |
| Gate Resistance | R _g | f = 1 MHz | | 7 | | Ω | |
| Turn-On Delay Time ^c | t _{d(on)} | | | 8 | 15 | | |
| Rise Time ^c | t _r | $V_{DD} = -30 \text{ V}, R_L = 3 \Omega$ | | 9 | 15 | | |
| Turn-Off Delay Time ^c | t _{d(off)} | $I_D \cong -19 \text{ A}, V_{GEN} = -10 \text{ V}, R_g = 2.5 \Omega$ | | 65 | 100 | ns | |
| Fall Time ^c | t _f | | | 30 | 45 | | |
| Drain-Source Body Diode and Charact | eristics (T _C = 2 | 5 °C) ^b | | | | | |
| Continuous Current | Is | | | | - 30 | | |
| Pulsed Current | I _{SM} | | | | - 30 | A | |
| Forward Voltage ^a | V _{SD} | I _F = - 19 A, V _{GS} = 0 V | | - 1 | - 1.5 | V | |
| Reverse Recovery Time | t _{rr} | I _F = - 19 A, di/dt = 100 A/μs | | 41 | 61 | ns | |

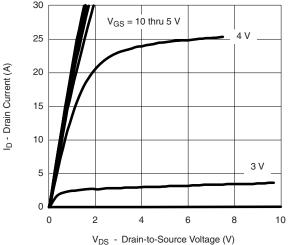
Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

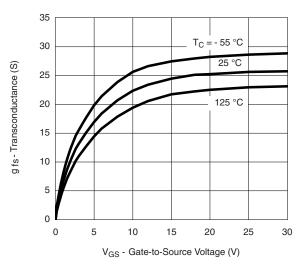
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



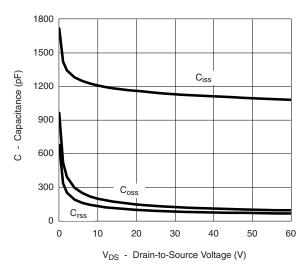
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Output Characteristics

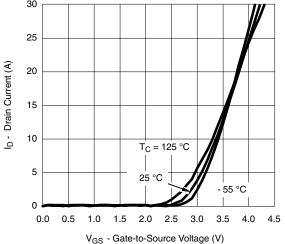


Transconductance

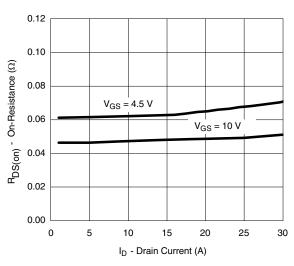


Capacitance

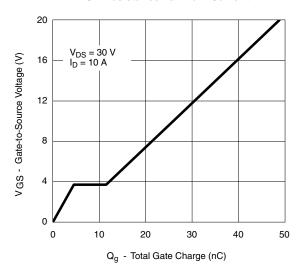
30



Transfer Characteristics



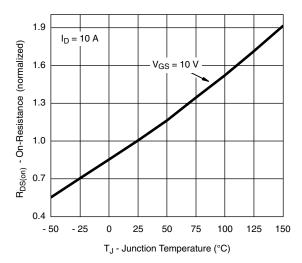
On-Resistance vs. Drain Current



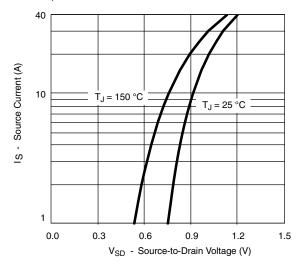
Gate Charge



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

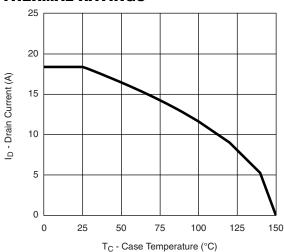


On-Resistance vs. Junction Temperature

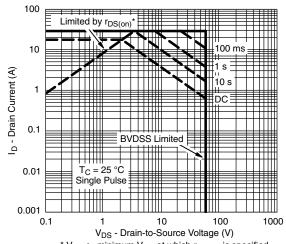


Source-Drain Diode Forward Voltage

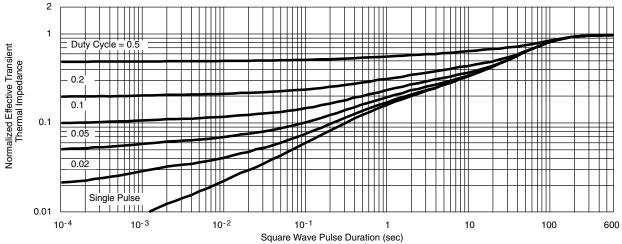
THERMAL RATINGS



Maximum Drain Current vs. Case Temperature



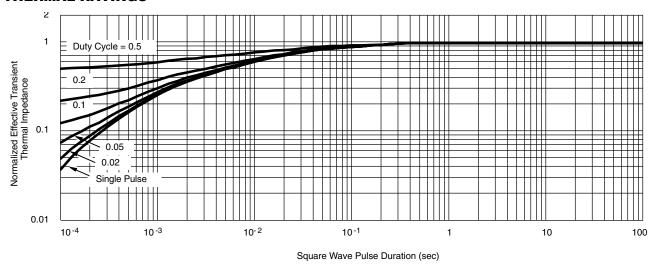
* V_{GS} > minimum V_{GS} at which r_{DS(on)} is specified **Safe Operating Area**



Normalized Thermal Transient Impedance, Junction-to-Ambient



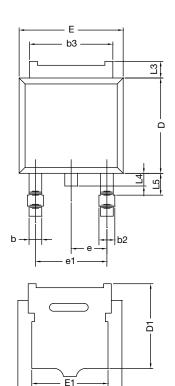
THERMAL RATINGS

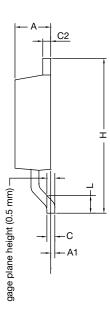


Normalized Thermal Transient Impedance, Junction-to-Case



TO-252AA Case Outline





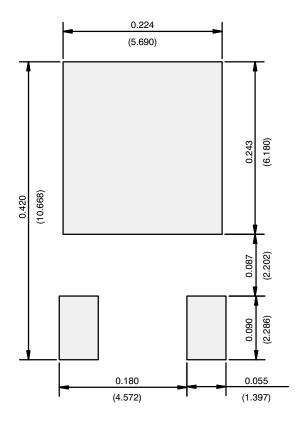
| | MILLIMETERS | | INC | HES | |
|---------------------------------|-------------|-------|-----------|-------|--|
| DIM. | MIN. | MAX. | MIN. | MAX. | |
| Α | 2.18 | 2.38 | 0.086 | 0.094 | |
| A1 | - | 0.127 | - | 0.005 | |
| b | 0.64 | 0.88 | 0.025 | 0.035 | |
| b2 | 0.76 | 1.14 | 0.030 | 0.045 | |
| b3 | 4.95 | 5.46 | 0.195 | 0.215 | |
| С | 0.46 | 0.61 | 0.018 | 0.024 | |
| C2 | 0.46 | 0.89 | 0.018 | 0.035 | |
| D | 5.97 | 6.22 | 0.235 | 0.245 | |
| D1 | 4.10 | - | 0.161 | - | |
| Е | 6.35 | 6.73 | 0.250 | 0.265 | |
| E1 | 4.32 | - | 0.170 | - | |
| Н | 9.40 | 10.41 | 0.370 | 0.410 | |
| е | 2.28 | BSC | 0.090 BSC | | |
| e1 | 4.56 BSC | | 0.180 BSC | | |
| L | 1.40 | 1.78 | 0.055 | 0.070 | |
| L3 | 0.89 | 1.27 | 0.035 | 0.050 | |
| L4 | - | 1.02 | - | 0.040 | |
| L5 | 1.01 | 1.52 | 0.040 | 0.060 | |
| ECN: T16-0236-Rev. P, 16-May-16 | | | | | |

DWG: 5347

• Dimension L3 is for reference only.



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)



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